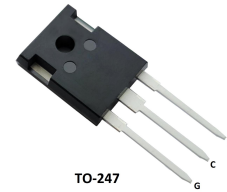


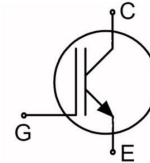
## Features

- Low gate charge
- Trench-Stop Technology
- High speed switching
- Saturation voltage:  $V_{CE(sat),typ} = 1.25V @ I_C=80A$  and  $T_C=25^\circ C$



## Applications

- General purpose inverters
- Induction heating(IH)
- Welding Converters
- UPS



## Absolute Ratings ( $T_C=25^\circ C$ )

Parameter	Symbol	MSG80D60FLC	Unit
Collector-Emmitter Voltage	$V_{ces}$	600	V
Collector Current-continuous	$I_C T_C=25^\circ C$	80	A
	$T_C=100^\circ C$	40	
Collector Current-pulse(note 1)	$I_{CM}$	300	A
Continuous Gate-Emmitter Voltage	$V_{GE}$	$\pm 20$	V
Transient Gate-emitter voltage	$V_{GE}$	$\pm 30$	V
Power Dissipation	$P_D T_C=25^\circ C$	260	W
Operating Temperature Range	$T_J$	-55~+150	$^\circ C$
Storage Temperature Range	$T_{STG}$	-55~150	$^\circ C$
Maximum Lead Temperature for Soldering Purposes	$T_L$	300	$^\circ C$

## Thermal Characteristic

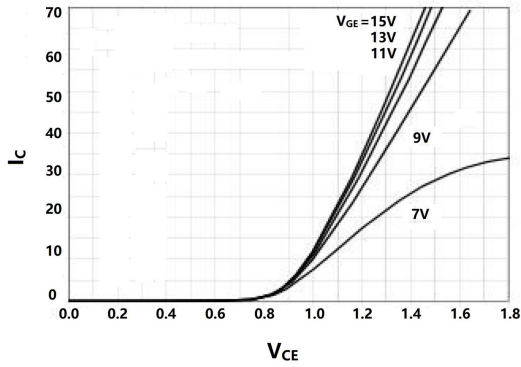
Parameter	Symbol	Tests conditions	Min	Typ	Max	Units
Off-Characteristics						
Collector-Emmitter Voltage	$BV_{CES}$	$I_C=250\mu A, V_{GE}=0V$	600	-	-	V
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE}=V_{CES}, V_{GE}=0V, T_J=125^\circ C$			25	$\mu A$
					250	
Gate-body leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=\pm 20V$	-	-	$\pm 100$	nA

Transconductance	gfs	$V_{CE}=10V, I_C=50A$	30	48	-	S
<b>On-Characteristics</b>						
Gate-Emmitter Threshold Voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}, I_C=250\mu A$	3.0	-	5.0	V
Collector-Emmitter saturation Voltage	$V_{CESAT}$	$V_{GE}=15V, I_C=80A$ (1)		1.25	1.35	V
<b>Dynamic Characteristics</b>						
Input capacitance	Cies	$V_{CE}=25V, V_{GE}=0V, f=1.0MHz$	-	3190	-	pF
Output capacitance	Coes		-	175	-	pF
Reverse transfer capacitance	Cres		-	43	-	pF
<b>Switching Characteristics</b>						
Turn-On delay time	$t_d(on)$	$V_{CE}=480V, I_C=60A, R_G=5\Omega, V_{GE}=15.0V, T_J=25^\circ C$ Inductive Load	-	25	-	ns
Turn-On rise time	$t_r$		-	30	-	ns
Turn-off delay time	$t_d(off)$		-	334	-	ns
Turn-off Fall time	$t_f$		-	224	-	ns
Turn-on energy	$E_{on}$		-	0.95	-	mJ
Turn-off energy	$E_{off}$		-	2.90	-	mJ
Total Gate Charge	$Q_g$		$V_{CE}=0.5 \cdot V_{CES}, I_C=50A, V_{GE}=15V$ (note3,4)	-	110	-
Gate to emitter charge	$Q_{ge}$			21		nC
Gate to collector charge	$Q_{gc}$			42		nC

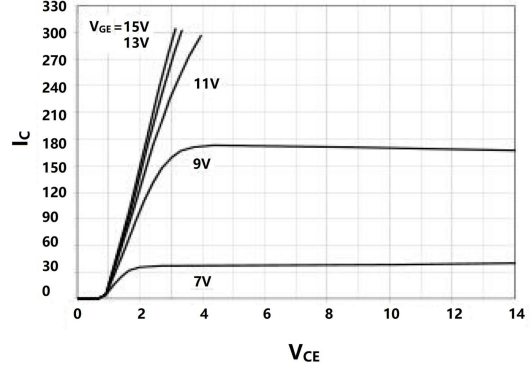
Parameter	Symbol	Max	Unit
IGBT Thermal Resistance, Junction to Case	$R_{th(j-c)}$	0.48	K/W
Thermal Resistance, Junction to Ambient	$R_{th(j-A)}$	40	K/W

### Electrical Characteristics (curves)

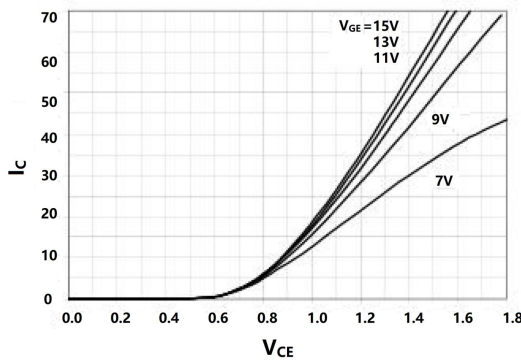
Output Characteristics @25°C



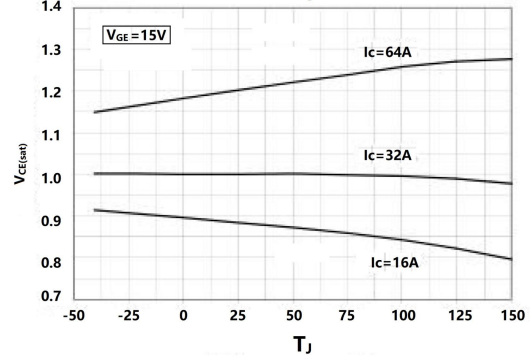
Extended Output Characteristics @25°C



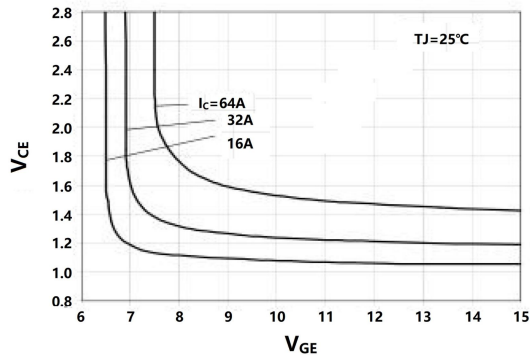
Output Characteristics @125°C



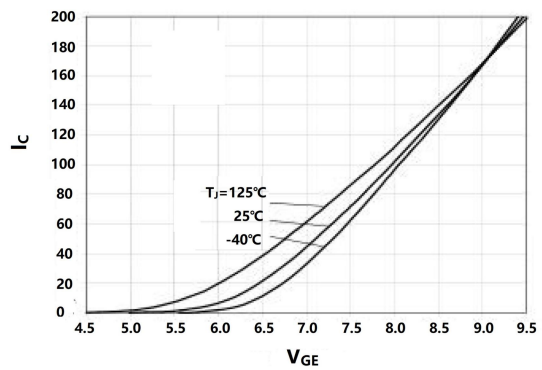
Dependence of VCE(sat) on Junction Temperature



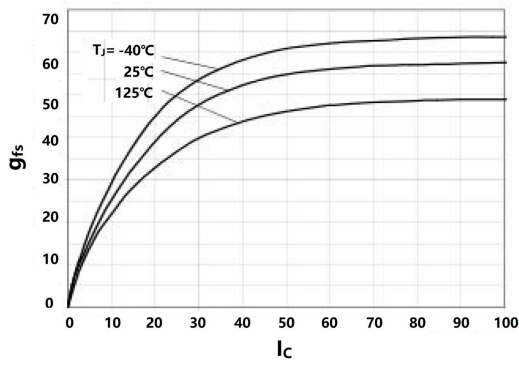
Collector to Emitter Voltage vs. Gate to Emitter Voltage



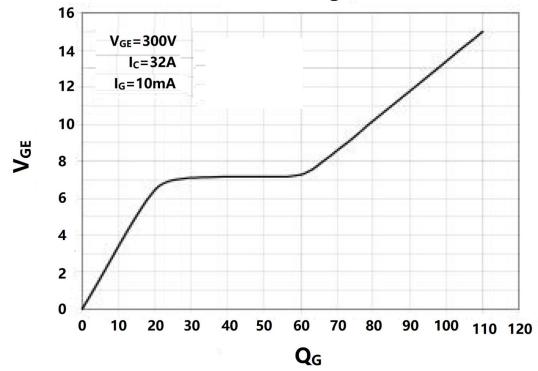
Input Admittance



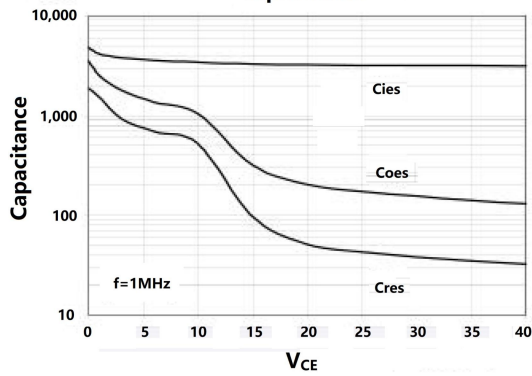
**Transconductance**



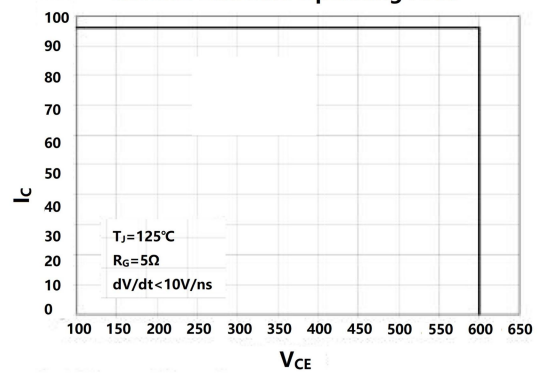
**Gate Charge**



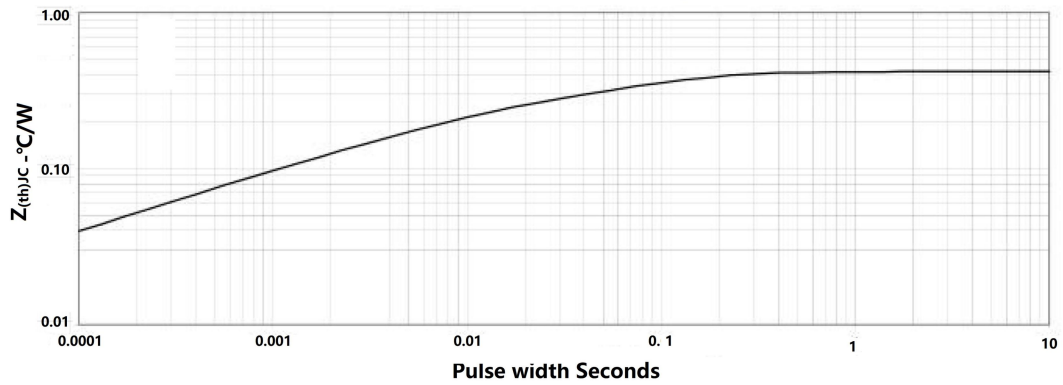
**Capacitance**



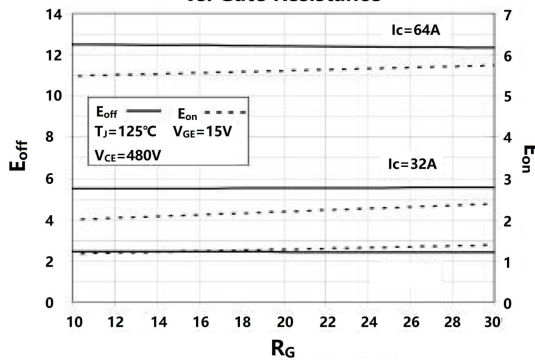
**Reverse Bias Safe Operating Area**



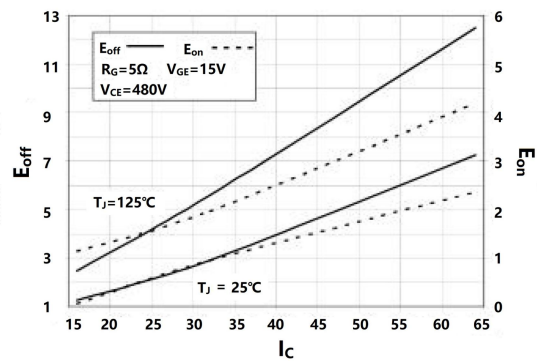
**Maximum Transient Thermal Impedance**



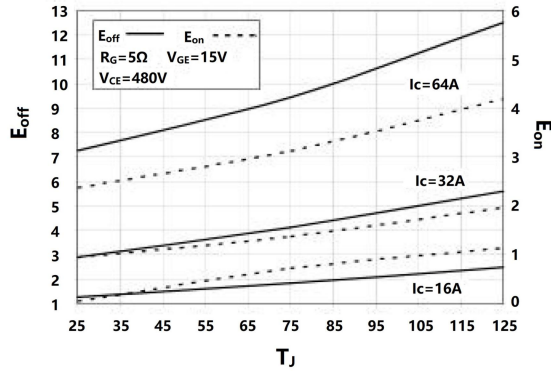
**inductive Switching Energy Loss vs. Gate Resistance**



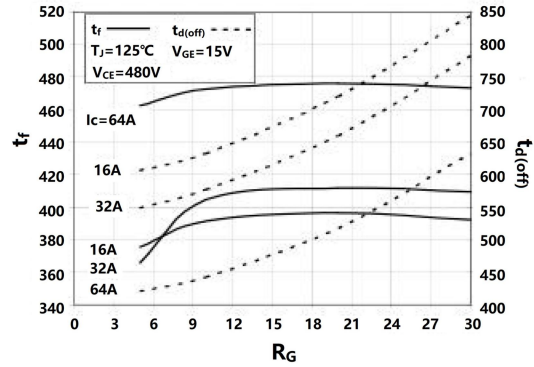
**inductive Switching Energy Loss vs. Collector Current**



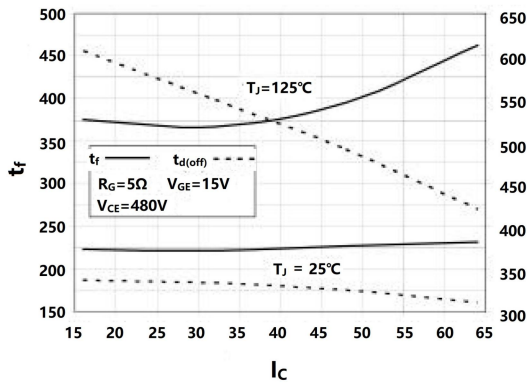
**inductive Switching Energy Loss vs. Junction Temperature**



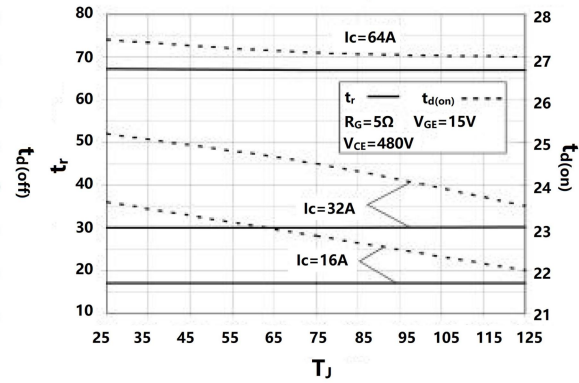
**inductive Turn-off Switching Times vs. Gate Resistance**



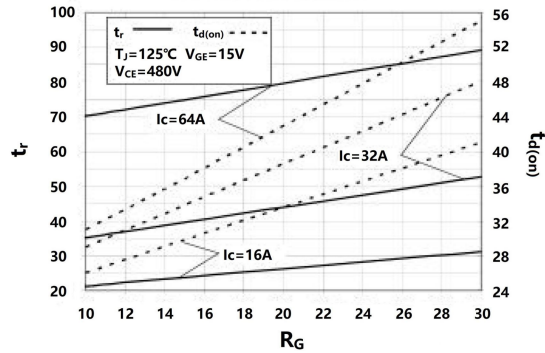
**inductive Turn-off Switching Times vs. Collector Current**



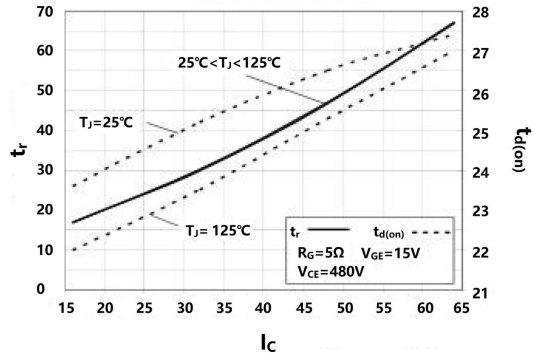
**inductive Turn-on Switching Times vs. Junction Temperature**



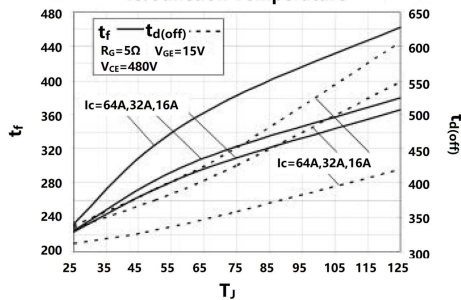
**Inductive Turn-on Switching Times vs. Gate Resistance**



**Inductive Turn-on Switching Times vs. Collector Current**



**Inductive Turn-on Switching Times vs. Junction Temperature**



### Package Mechanical DATA

